



## 3.2x1.6mm INFRARED EMITTING DIODE

#### **Features**

• Long life and robust package

•Standard Package: 2,000pcs/ Reel

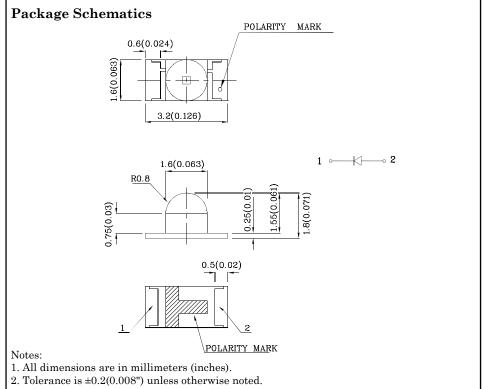
ullet MSL (Moisture Sensitivity Level): 3

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 $\bullet RoHS$  compliant







3. Specifications are subject to change without notice.

Absolute Maximum Ratings ( $T_A$ =25°C)		THI (GaAlAs)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$I_{\mathrm{F}}$	50	mA	
Forward Current (Peak) 1/100 Duty Cycle 10us Pulse Width	$i_{\mathrm{FS}}$	1200	mA	
Power Dissipation	$P_D$	80	mW	
Operating Temperature	$T_{\mathrm{A}}$	-40 ~ +85	$^{\circ}\mathrm{C}$	
Storage Temperature	Tstg	-40 ~ +85		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)		THI (GaAlAs)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.3	V	
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.6	V	
Reverse Current (Max.) $(V_R=5V)$	$I_{ m R}$	10	uA	
Wavelength of Peak Emission CIE127-2007*(Typ.) $(I_F=20\text{mA})$	λΡ	880*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	50	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	90	pF	

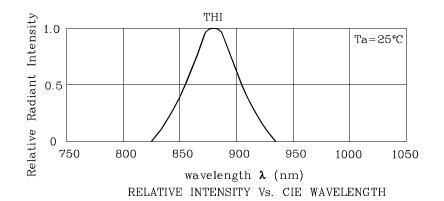
Part Number	Emitting Material	Lens-color	CIE127	Intensity 7-2007* hW/sr) lmA	Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
			min.	typ.		
XZTHI55W-3	GaAlAs	Water Clear	1.6*	3.8*	880*	40°

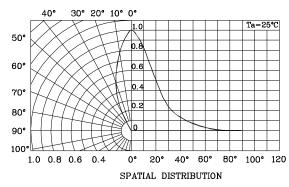
<sup>\*</sup>Radiant intensity value and wavelength are in accordance with CIE127-2007 standards.

XDSA1797 V9-Z Layout: Maggie L.

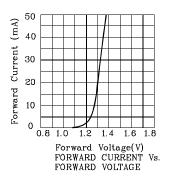


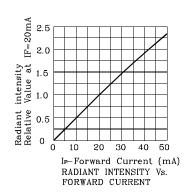


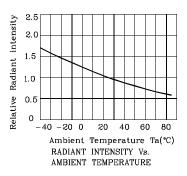




#### **❖** THI

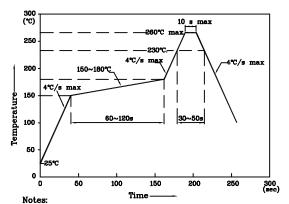






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

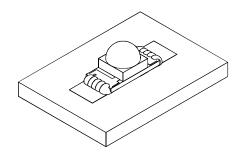


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions





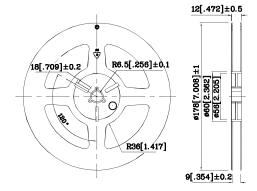
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



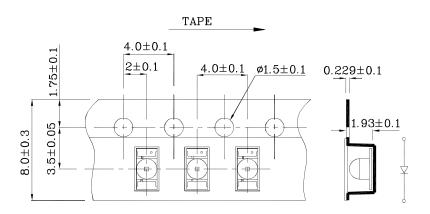
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



## \* Reel Dimension



# **❖** Tape Specification (Units:mm)



# Remarks:

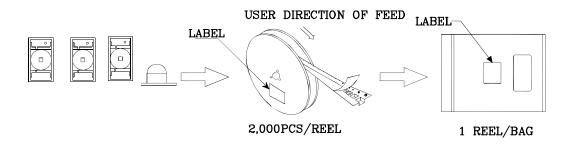
If special sorting is required (e.g. binning based on forward voltage or radiant intensity / luminous flux), the typical accuracy of the sorting process is as follows:

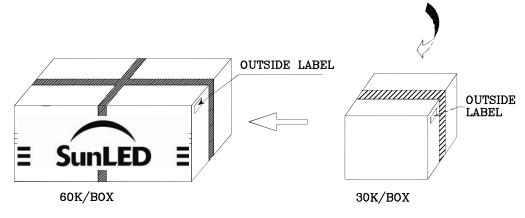
- 1. Radiant Intensity / Luminous Flux: +/-15%
- 2. Forward Voltage: +/-0.1V

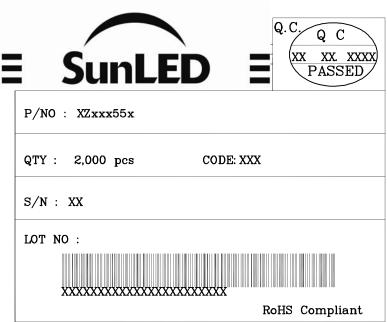
Note: Accuracy may depend on the sorting parameters



#### PACKING & LABEL SPECIFICATIONS







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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp

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